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Vishay Siliconix

N-Channel 100 V (D-S) MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	100					
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0088					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 7.5 \text{ V}$	0.0094					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.0120					
Q _g typ. (nC)	20.7					
I _D (A) ^a	18.4					
Configuration	Single					

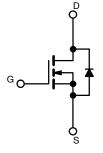
FEATURES

- TrenchFET® power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- DC/DC primary side switch
- Telecom/server
- Industrial



N-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4190ADY-T1-GE3			

PARAMETER Drain-source voltage Gate-source voltage		SYMBOL	LIMIT	UNIT	
		V _{DS}	100 ± 20	v	
		V _{GS}			
	T _C = 25 °C		18.4		
Continuous dusin suurent (T. 150 °C)	T _C = 70 °C		14.6		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	13 ^{b, c}		
	T _A = 70 °C		10.3 ^{b, c}		
Pulsed drain current (t = 300 µs)		I _{DM}	70	A	
Continuous source-drain diode current	T _C = 25 °C		5.4		
	T _A = 25 °C	I _S	2.7 ^{b, c}		
Single pulse avalanche current	. 0.1	I _{AS}	30		
Avalanche energy	L = 0.1 mH		45	mJ	
Maximum power dissipation	T _C = 25 °C		6		
	T _C = 70 °C	_	3.8		
	T _A = 25 °C	P _D	3 b, c	W	
	T _A = 70 °C		1.9 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient b, d	t ≤ 10 s	R _{thJA}	33	42	°C/W		
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	16	21			

Notes

- a. Based on $T_C = 25 \,^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. Maximum under steady state conditions is 85 $^{\circ}\text{C/W}$

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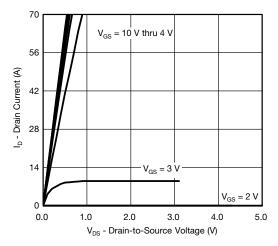
SPECIFICATIONS ($T_J = 25 ^{\circ}\text{C}$, PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	OTHIBOL	TEST SCREETISING	141114.	1	WAX.	Olti	
Drain-source breakdown voltage	V_{DS}	V _{GS} = 0 V, I _D = 250 μA	100	_	_	V	
V _{DS} temperature coefficient	ΔV _{DS} /T _J		-	64	_	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	_	-5.8	_		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	1.5	_	2.8	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	_	± 100	nA	
<u> </u>	400	V _{DS} = 100 V, V _{GS} = 0 V	_	-	1		
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$		10	μA		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	_	-	Α	
	2(0.1)	V _{GS} = 10 V, I _D = 15 A	-	0.0073	0.0088		
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 7.5 V, I _D = 12 A	-	0.0078	0.0094	Ω	
	= =(=:,)	V _{GS} = 4.5 V, I _D = 10 A	-	0.0096	0.0120		
Forward transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A	-	54	-	S	
Dynamic ^b							
Input capacitance	C _{iss}		-	1970	-	pF	
Output capacitance	C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz	-	695	-		
Reverse transfer capacitance	C _{rss}		-	62	-		
Total gate charge	Q _g	V _{DS} = 50 V, V _{GS} = 10 V, I _D = 10 A	-	44.4	67	nC	
		-	-	20.7	31		
Gate-source charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	6.1	-		
Gate-drain charge	Q _{gd}		-	9.1	-		
Output charge	Q _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}$	-	56	85		
Gate resistance	R _g	f = 1 MHz	0.4	1.1	2.2	Ω	
Turn-on delay time	t _{d(on)}		-	15	30		
Rise time	t _r	$V_{DD} = 50 \text{ V}, R_{L} = 5 \Omega$	-	11	22	- - -	
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$	-	31	60		
Fall time	t _f		-	10	20		
Turn-on delay time	t _{d(on)}		-	12	24	ns	
Rise time	t _r	$V_{DD} = 50 \text{ V}, R_{L} = 5 \Omega$	-	10	20	-	
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	34	65		
Fall time	t _f		-	10	20		
Drain-Source Body Diode Characterist	ics						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	5.4	^	
Pulse diode forward current ^a	I _{SM}		-	-	70	A	
Body diode voltage	V_{SD}	I _S = 5 A	-	0.76	1.1	V	
Body diode reverse recovery time	t _{rr}		-	42	80	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs,	-	40	80	nC	
Reverse recovery fall time	t _a	T _J = 25 °C	-	19	-		
•						ns	

Notes

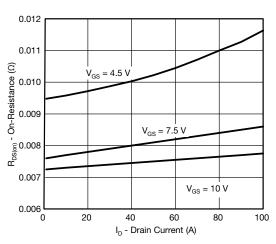
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

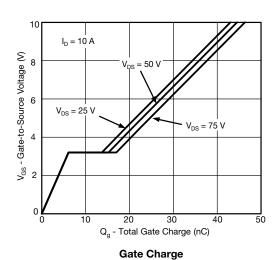


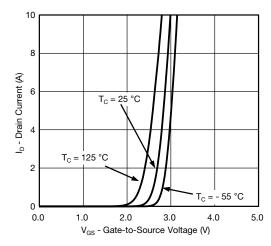


Output Characteristics

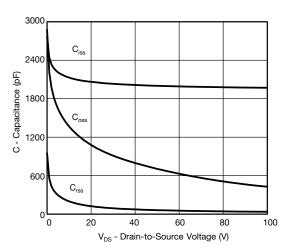


On-Resistance vs. Drain Current

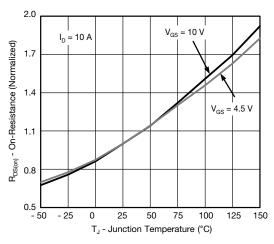




Transfer Characteristics

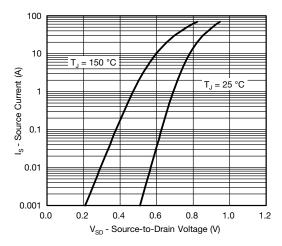


Capacitance

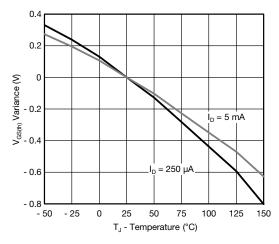


On-Resistance vs. Junction Temperature

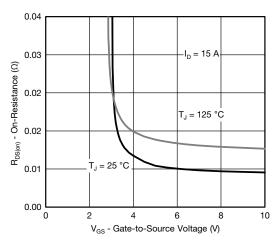




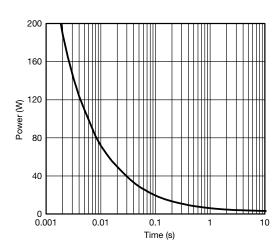
Source-Drain Diode Forward Voltage



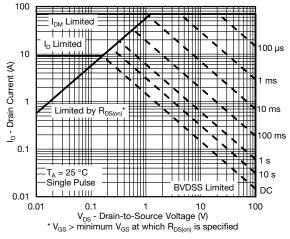
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

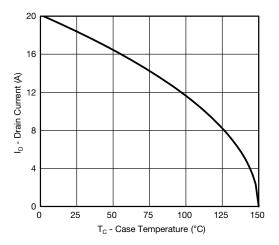


Single Pulse Power, Junction-to-Ambient

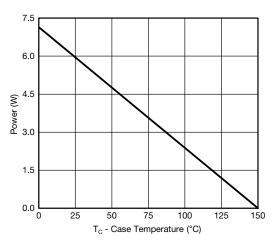


Safe Operating Area, Junction-to-Ambient

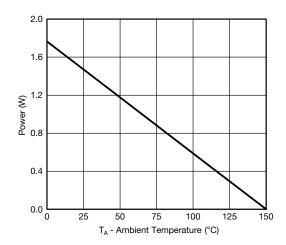




Current Derating a





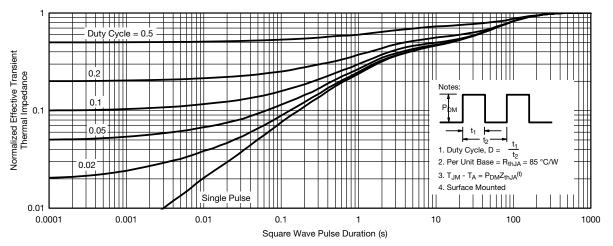


Power, Junction-to-Ambient

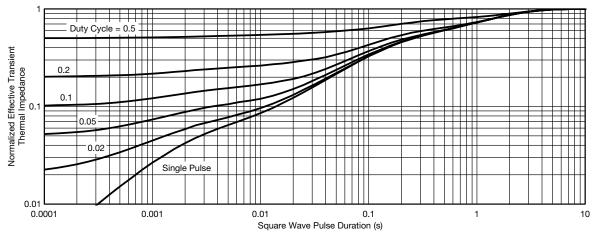
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63826.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

LON NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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